

TYPES 3N211, 3N212, 3N213
N-CHANNEL DUAL-GATE DEPLETION-TYPE
INSULATED-GATE FIELD-EFFECT TRANSISTORS

*3N211 operating characteristics at 25°C free-air temperature

PARAMETER	TEST CONDITIONS	3N211			UNIT
		MIN	TYP	MAX	
F Common-Source Spot Noise Figure	V _{DD} = 24 V, V _{GG} = 6 V, f = 45 MHz, See Figure 5		4	dB	
G _{ps} Small-Signal Common-Source Insertion Power Gain		29	37	dB	
B Bandwidth		3.5	6	MHz	
V _{GG(GC)} Gain-Control Gate-Supply voltage	V _{DD} = 24 V, ΔG _{ps} = -30 dB [†] , f = 45 MHz, See Figure 5		+1	-1	V
F Common-Source Spot Noise Figure	V _{DD} = 18 V, V _{GG} = 7 V, f = 200 MHz, See Figure 6		3.5	dB	
G _{ps} Small-Signal Common-Source Insertion Power Gain		24	35	dB	
B Bandwidth		5	12	MHz	
V _{GG(GC)} Gain-Control Gate-Supply Voltage	V _{DD} = 18 V, ΔG _{ps} = -30 dB [‡] , f = 200 MHz, See Figure 6		0	-2	V
F Common-Source Spot Noise Figure	V _{DS} = 15 V, V _{G2S} = 4 V, I _D = 15 mA, f = 450 MHz, See Figures 7 and 9		5	dB	
G _{ps} Small-Signal Common-Source Insertion Power Gain			21	dB	

[†]ΔG_{ps} at 45 MHz is defined as the change in G_{ps} from the value at V_{GG} = 6 volts.

[‡]ΔG_{ps} at 200 MHz is defined as the change in G_{ps} from the value at V_{GG} = 7 volts.

*3N212 operating characteristics at 25°C free-air temperature

PARAMETER	TEST CONDITIONS	3N212		UNIT
		MIN	MAX	
G _{ps(conv)} Small-Signal Conversion Power Gain	V _{DD} = 18 V, f _{LO} = 245 MHz [§] ,	21	28	dB
B Bandwidth	f _{RF} = 200 MHz, See Figure 8	4	7	MHz

[§] Amplitude at input from local oscillator is adjusted for maximum G_{ps(conv)}.

*3N213 operating characteristics at 25°C free-air temperature

PARAMETER	TEST CONDITIONS	3N213		UNIT
		MIN	MAX	
F Common-Source Spot Noise Figure	V _{DD} = 24 V, V _{GG} = 6 V, f = 45 MHz, See Figure 5		4	dB
G _{ps} Small-Signal Common-Source Insertion Power Gain		27	35	dB
B Bandwidth		3.5	6	MHz
V _{GG(GC)} Gain-Control Gate-Supply Voltage	V _{DD} = 24 V, ΔG _{ps} = -30 dB [†] , f = 45 MHz, See Figure 5		+1	V
			-1	

[†]ΔG_{ps} at 45 MHz is defined as the change in G_{ps} from the value at V_{GG} = 6 volts.

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TYPICAL CHARACTERISTICS AT $T_A = 25^\circ\text{C}$

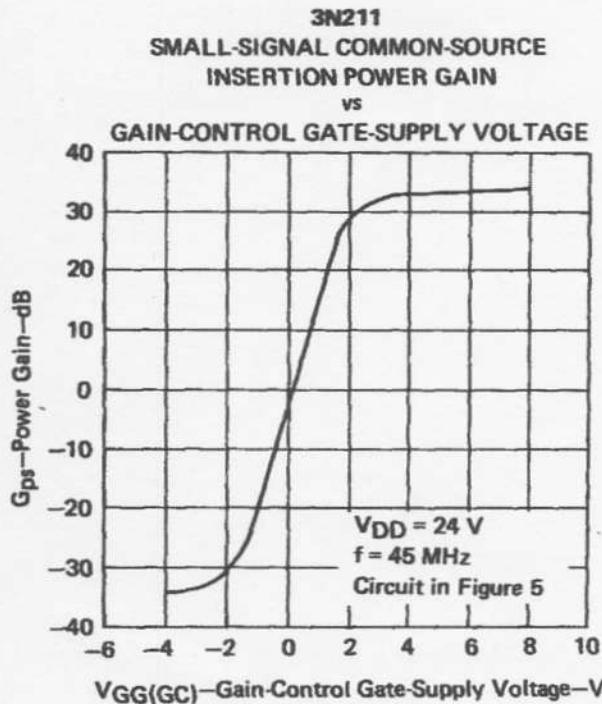


FIGURE 1

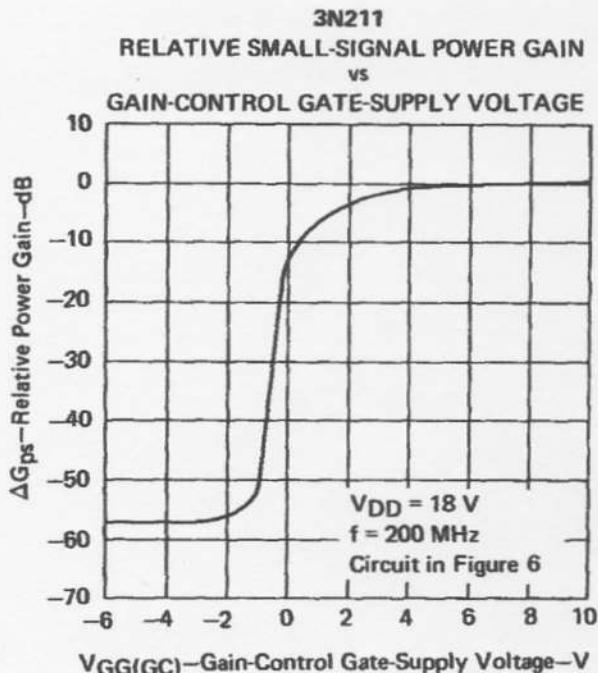


FIGURE 2

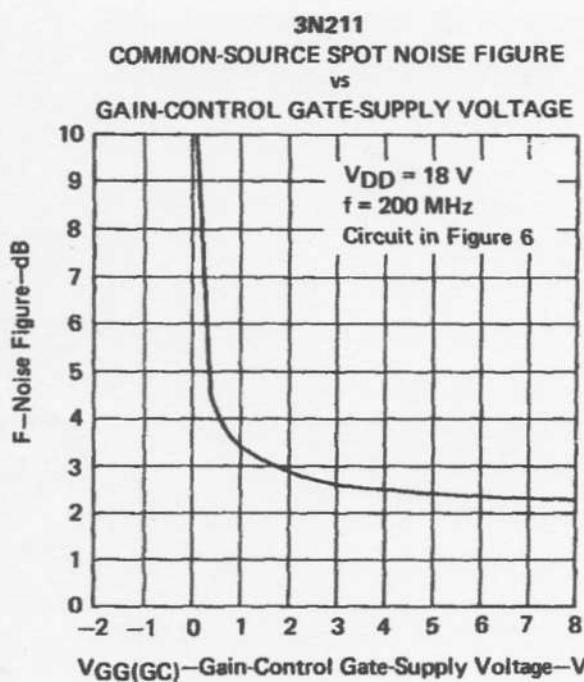


FIGURE 3

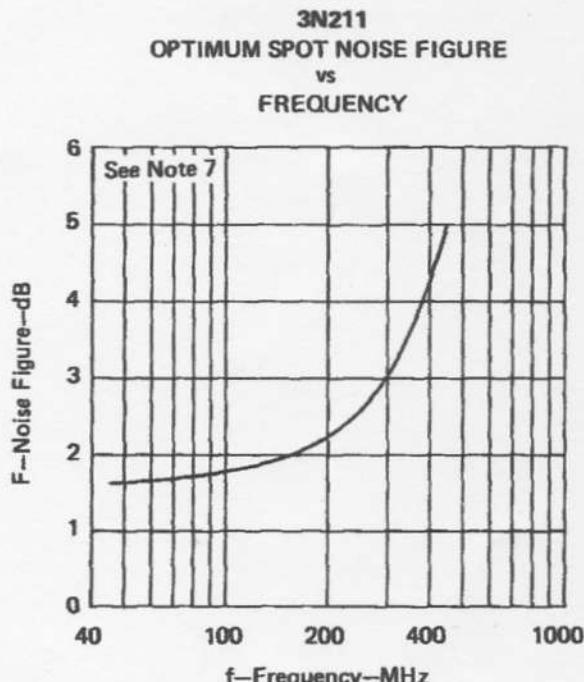
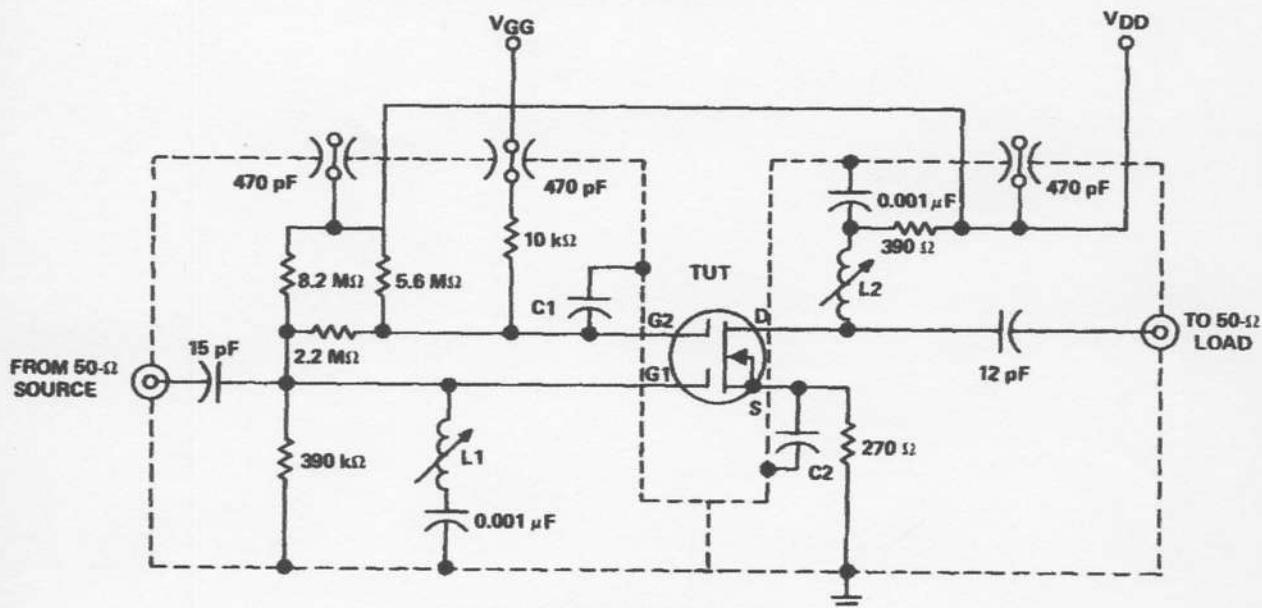


FIGURE 4

NOTE 7: Test conditions at 45 MHz, 200 MHz, and 450 MHz are the conditions given in the table of operating characteristics for 3N211.

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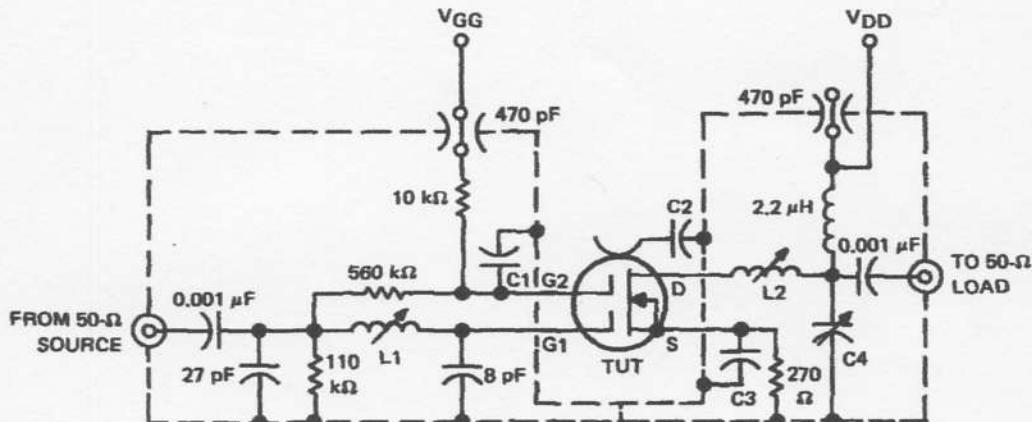
PARAMETER MEASUREMENT INFORMATION



CIRCUIT COMPONENT INFORMATION

- C1: Leadless disc ceramic, 0.001 μ F
- C2: Leadless disc ceramic, 0.01 μ F
- L1: BT # 2B, 5/32-inch-dia form, type "J" slug
- L2: 9T # 2B, 5/32-inch-dia form, type "J" slug

FIGURE 5—45-MHz POWER GAIN AND NOISE FIGURE TEST CIRCUIT FOR 3N211 AND 3N213*



CIRCUIT COMPONENT INFORMATION

- C1, C2, & C3: Leadless disc ceramic, 0.001 μ F
- C4: ARCO 462, 5-80 pF, or equivalent
- L1: 3T #18, 3/16-inch-dia aluminum slug
- L2: BT #20, 3/16-inch-dia aluminum slug

FIGURE 6—200-MHz POWER GAIN, GAIN-CONTROL VOLTAGE, AND NOISE FIGURE TEST CIRCUIT FOR 3N211*

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PARAMETER MEASUREMENT INFORMATION

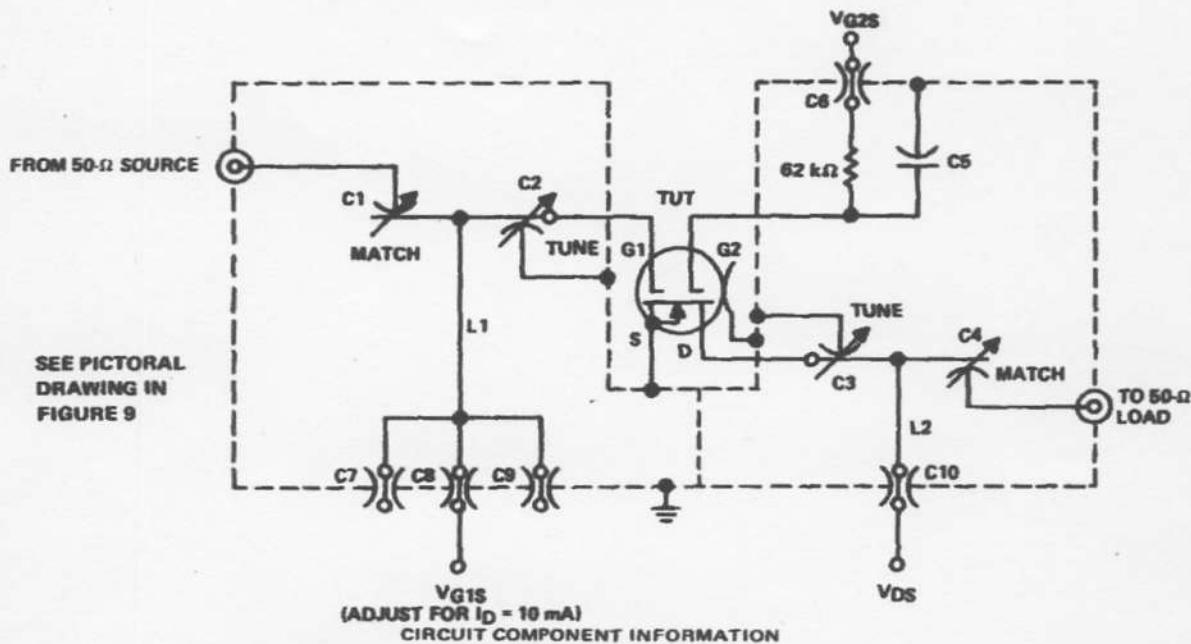
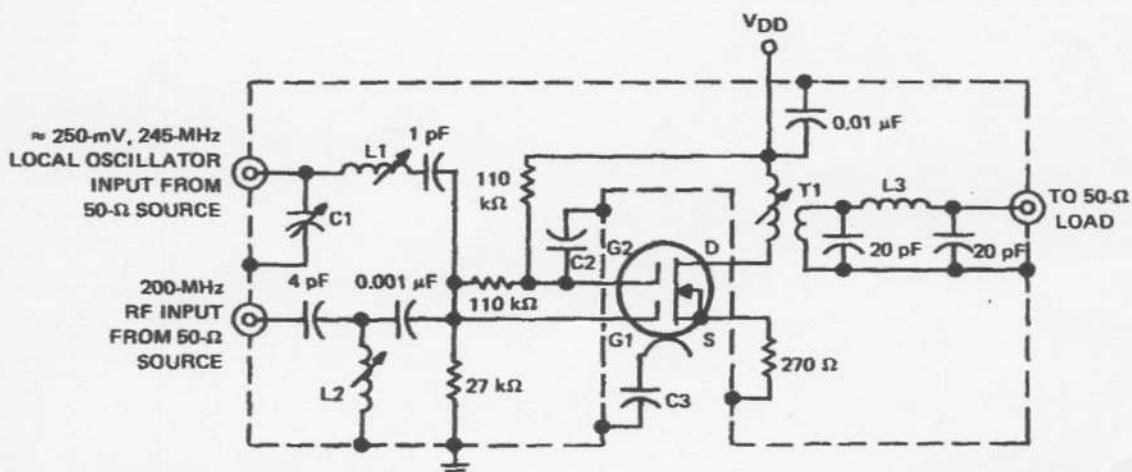


FIGURE 7—450-MHz POWER GAIN AND NOISE TEST CIRCUIT FOR 3N211



L1: 7T #34, 1/4-inch dia., aluminum slug
L2: 3T #20, 1/4-inch dia., aluminum slug
L3: 7T #24, 1/4-inch dia., air core

C1: Arco type 462, 5-80 pF
C2: 0.001 μF leadless disc
C3: 0.01 μF leadless disc

T1: Pri: 25T #30, close wound on 1/4-inch-dia form, type "J" slug
Sec: 4T #30, centered over primary

FIGURE 8—200-MHz-to-45-MHz CIRCUIT FOR CONVERSION POWER GAIN FOR 3N212*

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NOTES:

- A. All dimensions are in inches.
- B. The removable top of test fixture is not shown.
- C. For clarity, the $62\text{ k}\Omega$ resistor, the source and gate-2 socket pins, and insulating stand-off terminals (ISOT) soldered into the fold of L1 and L2 respectively for mechanical support, are not shown in view A.
- D. C1 and C2 (C3 and C4) consist of shim brass and the "C" portion of L1 (L2) separated by air and the mylar tape covering the "C" portion of L1 (L2).

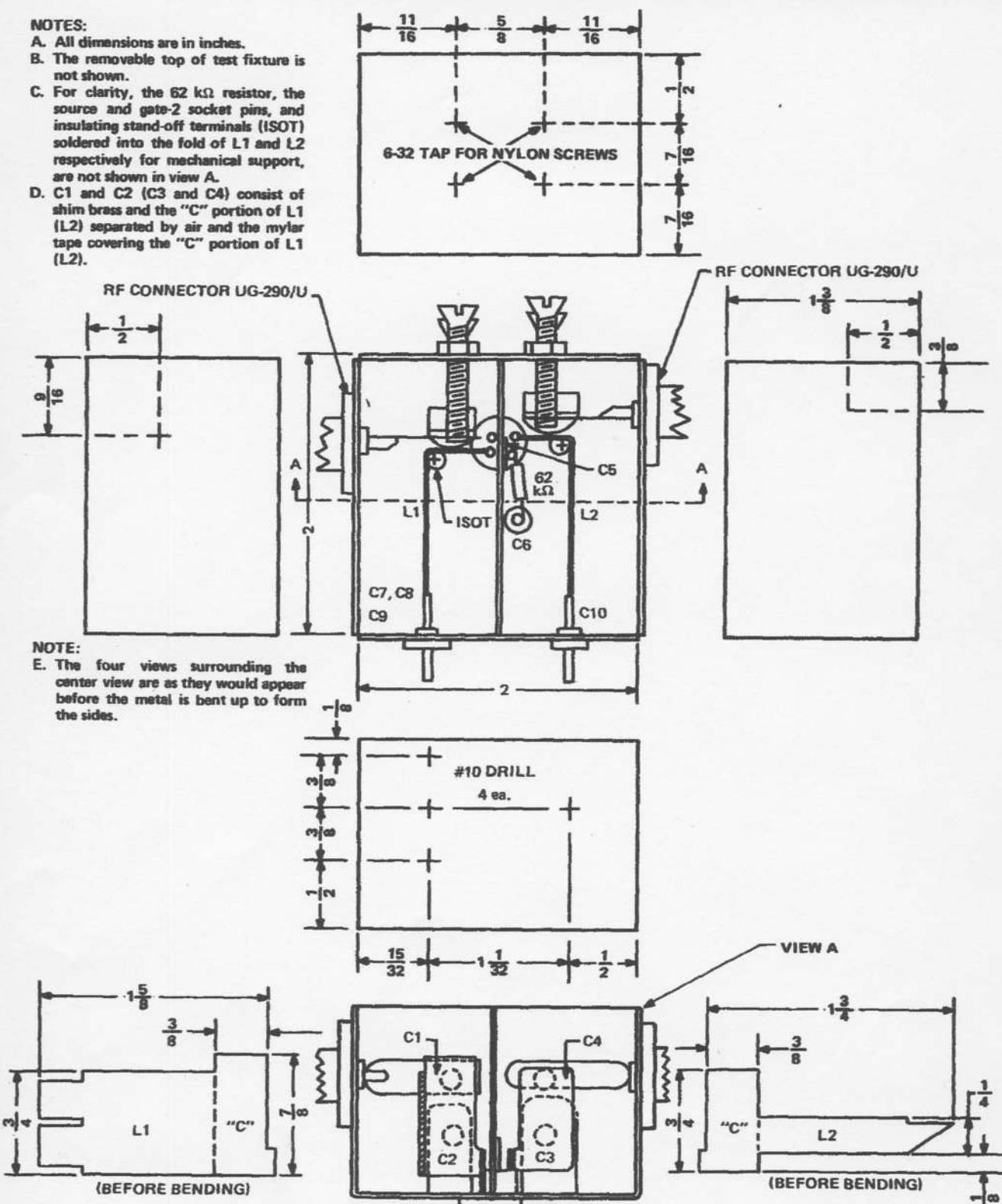


FIGURE 9—450-MHz POWER GAIN AND NOISE TEST FIXTURE